

CALL FOR PAPERS

● Important Dates

Submission Deadline: Nov. 13th, 2023
Notification Date: Nov. 29th, 2023
Registration Deadline: Dec. 11th, 2023

● Submission Methods

1. Submission System:
<http://confsys.iconf.org/submission/icnms2024>
2. Email box: icnms@saise.org

● Conference Topics

- * Materials behavior
 - * Casting and solidification
 - * Powder metallurgy and ceramic forming
 - * Surface, subsurface, and interface phenomena
 - * Coatings and surface engineering
 - * Nanomaterials and nanomanufacturing
- Please check the link which you can find more topics: <http://www.icnms.org/cfp.html>

● Contact Us

Conference Secretary: Ms. Evelyn Cheung
Email: icnms@saise.org

Patrons:



2024 12th International Conference on Nano and Materials Science ICNMS 2024

January 12-15, 2024 | Bangkok

www.icnms.org



Conference Committees

*Conference Chairs

Ramesh K. Agarwal (Fellow of IEEE, AAAS, AIAA, APS, ASME, CSAA, SME and ASEE), Washington University in St. Louis, USA

Zhang Dao Hua (Fellow of SAEng, InstP, IET), Nanyang Technological University, Singapore

Steven Y. Liang (Fellow of ASME & SME), Georgia Institute of Technology, USA

*Program Committee Chairs

Antonio Di Bartolomeo, Salerno University, Italy

Jing Wang, University of South Florida, USA

Yong Suk Yang, Pusan National University, South Korea

For more conference committees, please visit: <http://www.icnms.org/committees.html>

Keynote & Invited Speakers



Prof. Ramesh K. Agarwal
William Palm Professor of Engineering
Washington University in St. Louis, USA



Prof. Antonio Di Bartolomeo
Salerno University, Italy



Assoc. Prof. Vimolvan Pimpan
Chulalongkorn University, Thailand

Publication & Publication History

Accepted and presented papers will be published in **Materials Science Forum (ISSN print 0255-5476 / ISSN web 1662-9752)**, and will be indexed by **Scopus**, Inspec, DOAJ, etc.

*ICNMS 2023 - IEEE Xplore [ISBN: 978-1-6654-8804-4]

*ICNMS 2022 - Materials Science Forum Vol.1067 [ISBN: 978-3-0364-0133-1]-Ei Compendex & Scopus indexed

*ICNMS 2021 - Key Engineering Materials Vol.891 [ISBN: 978-3-0357-1789-1]-Ei Compendex & Scopus indexed

*ICNMS 2020 - IOP Conference Series: Materials Science and Engineering Vol. 842-Scopus indexed

*ICNMS 2019 - American Institute of Physics (AIP) Vol. 2083-Scopus indexed